

LEXANT™ RESIN 124R

REGION ASIA

DESCRIPTION

LEXANT™ 124R resin is a 18 MFR polycarbonate. 21 MVR. Grade designed for food contact. Mold release. UL94 HB rated. (For FDA, European food contact regulation, Japan, China and other agencies declarations worldwide, including any applied restrictions, contact your local SABIC representative).

TYPICAL PROPERTY VALUES

Revision 20201125

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL			
Tensile Stress, yld, Type I, 50 mm/min	62	MPa	ASTM D638
Tensile Stress, brk, Type I, 50 mm/min	68	MPa	ASTM D638
Tensile Strain, yld, Type I, 50 mm/min	7	%	ASTM D638
Tensile Strain, brk, Type I, 50 mm/min	125	%	ASTM D638
Flexural Stress, yld, 1.3 mm/min, 50 mm span	96	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	2340	MPa	ASTM D790
Hardness, Rockwell M	70	-	ASTM D785
Hardness, Rockwell R	118	-	ASTM D785
Taber Abrasion, CS-17, 1 kg	10	mg/1000cy	ASTM D1044
IMPACT			
Izod Impact, unnotched, 23°C	3204	J/m	ASTM D4812
Izod Impact, notched, 23°C	694	J/m	ASTM D256
Tensile Impact Strength, Type S	546	kJ/m ²	ASTM D1822
Falling Dart Impact (D 3029), 23°C	169	J	ASTM D3029
THERMAL			
Vicat Softening Temp, Rate B/50	154	°C	ASTM D1525
HDT, 0.45 MPa, 6.4 mm, unannealed	137	°C	ASTM D648
HDT, 1.82 MPa, 6.4 mm, unannealed	129	°C	ASTM D648
CTE, -40°C to 95°C, flow	6.84E-05	1/°C	ASTM E831
Specific Heat	1.25	J/g·°C	ASTM C351
Thermal Conductivity	0.19	W/m·°C	ASTM C177
Relative Temp Index, Elec	130	°C	UL 746B
Relative Temp Index, Mech w/impact	130	°C	UL 746B
Relative Temp Index, Mech w/o impact	130	°C	UL 746B
PHYSICAL			
Specific Gravity	1.2	-	ASTM D792
Specific Volume	0.83	cm ³ /g	ASTM D792
Density	1.19	g/cm ³	ASTM D792
Water Absorption, (23°C/24hrs)	0.15	%	ASTM D570
Water Absorption, (23°C/Saturated)	0.35	%	ASTM D570
Water Absorption, equilibrium, 100°C	0.58	%	ASTM D570
Mold Shrinkage, flow, 3.2 mm	0.5 – 0.7	%	SABIC method
Melt Flow Rate, 300°C/1.2 kgf	17.5	g/10 min	ASTM D1238
OPTICAL			

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Light Transmission, 2.54 mm	88	%	ASTM D1003
Haze, 2.54 mm	1	%	ASTM D1003
Refractive Index	1.586	-	ASTM D542
ELECTRICAL			
Volume Resistivity	>1.E+17	Ω.cm	ASTM D257
Dielectric Strength, in air, 3.2 mm	14.9	kV/mm	ASTM D149
Relative Permittivity, 50/60 Hz	3.17	-	ASTM D150
Relative Permittivity, 1 MHz	2.96	-	ASTM D150
Dissipation Factor, 50/60 Hz	0.0009	-	ASTM D150
Dissipation Factor, 1 MHz	0.01	-	ASTM D150
Hot Wire Ignition {PLC}	2	PLC Code	UL 746A
High Voltage Arc Track Rate {PLC}	2	PLC Code	UL 746A
High Ampere Arc Ign, surface {PLC}	1	PLC Code	UL 746A
Comparative Tracking Index (UL) {PLC}	2	PLC Code	UL 746A
FLAME CHARACTERISTICS			
UL Yellow Card Link	E207780-100726479	-	-
UL Yellow Card Link 2	E45587-236865	-	-
UL Recognized, 94HB Flame Class Rating	1.47	mm	UL 94
INJECTION MOLDING			
Drying Temperature	120	°C	
Drying Time	3 – 4	Hrs	
Drying Time (Cumulative)	48	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	280 – 305	°C	
Nozzle Temperature	275 – 300	°C	
Front - Zone 3 Temperature	280 – 305	°C	
Middle - Zone 2 Temperature	270 – 295	°C	
Rear - Zone 1 Temperature	260 – 280	°C	
Mold Temperature	70 – 95	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	40 – 70	rpm	
Shot to Cylinder Size	40 – 60	%	
Vent Depth	0.025 – 0.076	mm	

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